

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,059,948 B2
APPLICATION NO. : 10/026854
DATED : June 13, 2006
INVENTOR(S) : Li et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page, Item (75), Inventors: Please change "Llang-Yuh" to --Liang-Yuh--

Title Page, Item (56), References Cited, U.S. PATENT DOCUMENTS: Please include the following reference:

--5,328,716 7/1994 Buchanan--

Column 2, Lines 4-5: Change "substra The polishing pressure preferably has e next." to --substrate to the next.--

Column 6, Line 46: After "from", change "and" to --any--

Column 7, Line 64: Change "C₆H₁₂Na₂O₆S₄" to --C₆H₁₂Na₂O₆S₄--

Column 10, Line 35: Delete "between"

Column 10, Line 41: Change "my" to --may--

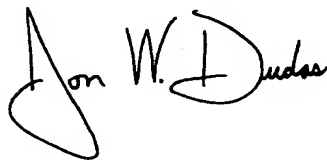
Column 11, Line 1: Change "Modem" --Modern--

Column 12, Line 17: Change "supporting" to --support--

Column 12, Line 57: Delete "may be utilized"

Signed and Sealed this

Sixteenth Day of January, 2007



JON W. DUDAS
Director of the United States Patent and Trademark Office